



Integrated Micro-Electronics, Inc.

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August 17, 2016

**Securities and Exchange Commission**  
SEC Building, EDSA, Mandaluyong City

Attention: Ms. Justina F. Callangan  
Director, Corporation & Finance Department

**Philippine Stock Exchange**  
Philippine Stock Exchange Plaza  
Ayala Triangle, Ayala Avenue, Makati City

Attention: Mr. Jose Valeriano B. Zuño III  
OIC – Head, Disclosure Department

Subject: **IMI Expands Technology and Product Portfolio with VIA optronics Acquisition**

Integrated Micro-Electronics Inc. (PH: IMI) and the shareholders of VIA optronics GmbH (VIA) announced the signing of a definitive agreement under which IMI will acquire a 76 percent stake in VIA, a leading optical bonding and display solutions provider, for EUR 47.4 million. Company founder Jürgen Eichner will retain a 24 percent ownership and continue to lead VIA as Managing Director, reporting to Arthur R. Tan, IMI's chief executive officer.

Please refer to the attached press release. Thank you.

Very truly yours,

**JAIME G. SANCHEZ**  
Vice President, Deputy CFO and Group Controller  
Compliance Officer



## PRESS RELEASE

### **IMI Expands Technology and Product Portfolio with VIA optronics Acquisition**

**August 17, 2016, Laguna, Philippines** — Integrated Micro-Electronics Inc. (PH: IMI) and the shareholders of VIA optronics GmbH (VIA) announced the signing of a definitive agreement under which IMI will acquire a 76 percent stake in VIA, a leading optical bonding and display solutions provider, for EUR 47.4 million. Company founder Jürgen Eichner will retain a 24 percent ownership and continue to lead VIA as Managing Director, reporting to Arthur R. Tan, IMI's chief executive officer. The acquisition is expected to be accretive to IMI's earnings per share starting 2017. The transaction, which will be financed through debt, is expected to close in the third quarter of 2016.

Alpina Partners is selling all of its 55% shareholding as part of the transaction. Alpina Partners has been a shareholder in the company since June 2010.

Optical bonding is a technology that significantly enhances the visibility and performance of display systems, especially for outdoor use. The technology also enhances the quality, throughput and efficiency of the display system integration process. VIA's bonding material and intellectual property on its optical bonding processes, which can enable high yield bonding for curved, plastic, 3D and large size applications, puts VIA in a strong position to address the growing demand for displays in automotive and industrial outdoor applications. VIA's experience in high reliability markets also matches IMI's existing offerings in the automotive, industrial and medical markets.

"This transaction represents a unique opportunity to accelerate IMI's growth and broaden VIA's opportunities by leveraging off of IMI's global footprint and resources," Tan said. Together, IMI and VIA will be best positioned to revolutionize the way the world experiences vision and touch on displays. We believe the acquisition will allow IMI to strengthen its partnerships with customers by offering complementary automotive camera and display monitor solutions for advanced driver assistance systems. We look forward to further developing and utilizing the synergies between the two companies."

"We announce today an exciting next chapter for VIA, as we have found the perfect strategic partner that is aligned with our values and growth ambitions," Eichner said. "Once combined, we will have the scale to introduce our patented technology into automotive camera monitor systems for increased safety and effectivity. IMI has a great cultural fit with our organization and I am excited for our employees to benefit from the long-term prospects of being part of IMI."

**About VIA**

VIA is a leading company in sunlight readable interactive display solutions including touch screens. Starting with industrial and high reliability products, the company has conquered all market segments as a leading provider for optical bonding, a key technology to lower reflections thus enabling sunlight readability and increasing robustness, which is mandatory to allow thinner and lighter portable display solutions. VIA has developed proprietary material for optical bonding and holds valuable intellectual property for bonding processes and equipment resulting in very high production yields. VIA was established in 2005 and has approximately 290 employees across four countries. Together with its headquarters in Schwarzenbruck, Germany, VIA has research facilities and manufacturing sites in Mörsdorf, Germany and Suzhou, China, and sales offices in Florida and Taipei.

**About Alpina Partners**

Alpina Partners is a London and Munich based investment firm with over €300 million in assets under management. Alpina focuses on European growth companies with a strong technical USP.

**About IMI**

Integrated Micro-Electronics Inc. (IMI) is one of the leading global providers of electronics manufacturing services (EMS) and power semiconductor assembly and test services with manufacturing facilities in Asia, Europe, and North America. It serves diversified markets that include those in the automotive, industrial, medical, telecommunications infrastructure, storage device, and consumer electronics industries. Committed to cost-effective and innovative customized solutions (from design and product development to manufacturing and order fulfillment), the company's comprehensive capabilities and global manufacturing presence allow it to take on specific outsourcing needs. A subsidiary of Ayala Corporation, IMI ranks 18th on the latest list of *Manufacturing Market Insider* for the top 50 EMS providers in the world based on the 2014 EMS-related revenues of companies. For more information, visit [www.global-imi.com](http://www.global-imi.com).